

Call for Papers

Track 9 - Real-Time and Networked Embedded Computing, IoT Technologies, and Applications

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❖ **FOCUS.** Real-time systems bring significant challenges and opportunities in embedded computing techniques to speed up industrial and commercial services. The emergence of Internet-of-Things (IoT) – a smart high-level concept of progressing the world through connecting and integrating all things into a huge network - has also been improving the communication efficiency for these services. A networked embedded computing has thus gradually been drawing developers' attention to be widely applied in abundant applications. This track focuses on models, techniques, methods, analysis and applications that are related to real-time and embedded computing and IoT based networking and technologies. General topics that are relevant to this track include, but are not limited to:

❖ TOPICS

- ❖ Innovations in real-time capable networks
- ❖ Software Defined Networks (SDN) and Time-Sensitive Networking (TSN)
- ❖ Hard Real-time SOA and RESTful industrial communication
- ❖ Real-time issues of distributed control in industrial CPS
- ❖ Industrial IoT protocols (OPC UA, DDS, MQTT, AMQP, COAP ...)
- ❖ Verification, validation of distributed embedded applications
- ❖ Security verification of RT(O)S and industrial automation systems
- ❖ Distributed control via industrial communication networks
- ❖ Factors influencing latencies in emerging industrial comm. systems
- ❖ Combining legacy RTN with emerging RT IP-based networks (TSN,SDN)
- ❖ Blockchain and distributed ledger technologies in NES and IoT applic.
- ❖ Deep learning technologies for distributed real-time embedded systems
- ❖ Performance analysis (of distributed real-time systems)
- ❖ Emerging real-time operating systems and real-time hypervisors
- ❖ Hard real-time services in edge and cloud
- ❖ Timing and resource analysis of (distributed) resource-constrained AI
- ❖ 5G for industrial applications

❖ **AIM.** IEEE INDIN is a flagship conference of IEEE Industrial Electronics Society providing a forum for presentation and discussion of the state-of-art and future perspectives of industrial information technologies, where industry experts, researchers, and academics share ideas and report on recent developments, deployments, technology trends and research results, as well as initiatives related to industrial informatics and their application.

❖ **CONFERENCE FORMAT.** The conference will include multitrack sessions, for both Regular and an Special Session papers, to present significant and novel research results with a prospect for a tangible impact on the research area and potential implementations; Industry Forum sessions, in which invited speakers will present use cases, changes, and challenges faced by industry associated with the technical areas of IES; and Tutorials sessions, in which selected speakers will explain state-of-the-art and ongoing hot research techniques and tools, together with hands-on experiments, aimed at solving problems faced by industrial informatics engineers and researchers.

❖ AUTHOR'S SCHEDULE (2021)

❖ Regular and Special Session (SS) papers

SS proposals deadlineJanuary 24
 Papers submission deadlineMarch 31
 Acceptance notificationJune 11
 Deadline for final manuscriptsJune 30

❖ Tutorials

Tutorial proposals deadline April 23

Track Programme Committee

- ❖ Luis Almeida, Univ. of Porto, PT
- ❖ Mohammad Ashjaei, Mälardalen Univ., SE
- ❖ Paulo Bartolomeu, Univ. of Aveiro, PT
- ❖ Moris Behnam, Mälardalen Univ., SE
- ❖ Reinder Bril, Tech. Univ. Eindhoven (TU/e), NL
- ❖ Wenbin Dai, Shanghai Jiao Tong Univ., CN
- ❖ Peter Danielis, Univ. of Rostock, DE
- ❖ Ramez Daoud, American Univ. in Cairo, EG
- ❖ Michael Ditzel, Stihl GmbH, DE
- ❖ Antonio Espirito-Santo, Univ. of Beira Interior, PT
- ❖ Tullio Fachinetti, Univ. of Pavia, IT
- ❖ Paolo Ferrari, Univ. of Brescia, IT
- ❖ Marisol García Valls, Univ. Polit. de València, ES
- ❖ Yacine Ghamri-Doudane, La Rochelle Univ., FR
- ❖ Rafia Inam, Ericsson, SE
- ❖ Stavros Koubias, Univ. of Patras, GR
- ❖ Luca Leonardi, Univ. of Catania, IT
- ❖ Michele Luvissotto, ABB Power Grids Sweden – AB Power Grids Research, SE
- ❖ Ahlem Mifdaoui, Univ. of Toulouse, FR
- ❖ Christoph Niedermeier, Siemens AG, DE
- ❖ Borislav Nikolic, Continental Autom. GmbH, DE
- ❖ Roman Obermaier, Univ. of Siegen, DE
- ❖ Zhibo Pang, ABB Corporate Research and Royal Institute of Technology, SE
- ❖ Michael Paulitsch, Intel, AT
- ❖ Paul Pop, Technical Univ. of Denmark, DK
- ❖ Bruno Quoitin, Univ. of Mons, BE
- ❖ Markus Rentschler, Balluff GmbH, DE
- ❖ Achim Rettberg, Univ. App. Sc. Hamm-Lippstadt, DE
- ❖ Stefano Rinaldi, Univ. of Brescia, IT
- ❖ Yang Shi, Univ. of Victoria, US
- ❖ Michael Short, Teesside Univ., UK
- ❖ Luis Silva, Instituto de Telecomunicacoes and Bosch/Ovar, PT
- ❖ Federico Tamarin, Univ. Modena e Reggio Emilia, IT
- ❖ Stavros Tripakis, Northeastern Univ., US
- ❖ Pal Varga, Budapest Univ. of Technology and Economics, HU
- ❖ Alexander Viehl, FZI Forschungszentrum Informatik, DE
- ❖ Feisheng Yang, Northwestern Polytech. Univ., CN
- ❖ Daesub Yoon, ETRI, KR
- ❖ Janusz Zalewski, Florida Gulf Coast Univ., US